

Short Communication

Synthesis, electromagnetic reflection loss and oxidation resistance of pyrolytic carbon-Si₃N₄ ceramics with dense Si₃N₄ coatingXiangming Li^{a,*}, Litong Zhang^b, Xiaowei Yin^b^a College of Water Resources and Architecture Engineering, Northwest Agriculture and Forestry University, Yangling, Shaanxi 712100, PR China^b National Key Laboratory of Thermostructure Composite Materials, Northwestern Polytechnical University, Xi'an, Shaanxi 710072, PR China

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Abstract

Si₃N₄-coated porous pyrolytic carbon-Si₃N₄ ceramics (PyC-Si₃N₄/Si₃N₄) were fabricated by chemical vapour infiltration of PyC into porous Si₃N₄ ceramic and then chemical vapour deposition of Si₃N₄ coating on the surface of the obtained PyC-Si₃N₄. The PyC-Si₃N₄/Si₃N₄ with 3.1 vol.% PyC content possesses electromagnetic reflection loss as low as −11.5 dB. Due to the excellent sealing effect of dense Si₃N₄ coating, the PyC-Si₃N₄/Si₃N₄ possesses good oxidation resistance, which makes PyC-Si₃N₄/Si₃N₄ a good electromagnetic absorbing material that can be used at temperature as high as 1100 °C.

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Keywords: Si₃N₄; Porosity; Carbon; Chemical vapour deposition; Functional applications**1. Introduction**

Reflection and absorption are two different ways in attenuating electromagnetic radiation. A common way of shielding electromagnetic wave is using materials with high conductivity, such as metal, as a shielding package. With the development of radar and microwave communication technology, it is in dire need of anti-electromagnetic interference technology, self-concealing materials and microwave darkrooms. It is known that the shielding of electromagnetic wave by absorption is more useful than that by reflection.

Compared with metal, carbon possesses good electromagnetic attenuating property and environmental stability, so carbon is a good absorbing agent which is usually added into another matrix to improve electromagnetic absorbing property. The electromagnetic shielding properties of polymers and ceramics containing carbon-based fillers (e.g., carbon blacks,^{1,2} graphite flakes,³ carbon fibres^{4,5} and nanotubes^{6–10}) have been extensively investigated. Due to the high electrical conductivity of carbon, above materials shield electromagnetic wave mainly by reflection.^{11,12} In addition, because of the bad oxidation

resistance of carbon, these materials can only be used at temperatures below 500 °C. Therefore, it is in dire need of fabricating carbon-based material not only with low electromagnetic reflection loss, but also with good oxidation resistance.

As known from our previous work,¹³ porous Si₃N₄ ceramic with dense Si₃N₄ coating (Si₃N₄/Si₃N₄) possesses good moisture resistance because of the sealing effect of dense Si₃N₄ coating. In the present work, pyrolytic carbon-Si₃N₄ ceramics (PyC-Si₃N₄) are fabricated by chemical vapour infiltration (CVI) of PyC into porous Si₃N₄ ceramic, and then PyC-Si₃N₄ ceramics with dense Si₃N₄ coating (PyC-Si₃N₄/Si₃N₄) are fabricated by chemical vapour deposition (CVD) of Si₃N₄ coating on the surface of the obtained PyC-Si₃N₄. The effect of PyC content on the electromagnetic reflection loss of PyC-Si₃N₄/Si₃N₄ and the effect of dense Si₃N₄ coating on the oxidation resistance of PyC-Si₃N₄/Si₃N₄ are investigated in detail.

2. Experimental*2.1. Sample preparation*

Porous Si₃N₄ ceramic fabricated in our previous work was machined into samples with dimensions of 2.8 mm × 10.1 mm × 22.8 mm. PyC was infiltrated into the samples by CVI using butane as precursor at 870 °C and a

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reduced pressure of 500 Pa. Si_3N_4 coating was deposited on the surface of the samples by CVD using silicon tetrachloride ($\text{SiCl}_4 \geq 99.99$ wt.%) and ammonia gas ($\text{NH}_3 \geq 99.99\%$) as precursors at 1100 °C and a reduced pressure of 2 kPa in argon atmosphere.¹³

2.2. Characterization

The porosity was measured by Archimedes method. The microstructure was observed by scanning electron microscopy (SEM, S-4700, Hitachi, Japan). The electromagnetic absorbing property was determined by calculating the electromagnetic reflection loss according to Eq. (1) shown as follows:

$$R = 20 \log \left| \frac{Z_{in} - 1}{Z_{in} + 1} \right| \quad (1)$$

where Z_{in} is the normalized input impedance of the electromagnetic absorption layer which is calculated according to Eq. (2) shown as follows:

$$Z_{in} = \sqrt{\frac{\mu_r}{\epsilon_r}} \tanh \left(j \frac{2\pi}{c} \sqrt{\mu_r \epsilon_r} f d \right) \quad (2)$$

where c is the light velocity in vacuum, f is the electromagnetic wave frequency, d is the thickness of the absorber, ϵ_r and μ_r are the relative permittivity and permeability of the absorber, respectively. In the present work, μ_r was taken as 1.0 because of the negligible magnetic property of $\text{PyC-Si}_3\text{N}_4/\text{Si}_3\text{N}_4$ ceramics. ϵ_r in frequency of 8.2–12.4 GHz is measured by vector network analyzer (VNA, MS4644A, Anritsu, Japan).

Table 1

Open porosities of $\text{PyC-Si}_3\text{N}_4$ and $\text{PyC-Si}_3\text{N}_4/\text{Si}_3\text{N}_4$ with different PyC content.

$\text{PyC-Si}_3\text{N}_4$		$\text{PyC-Si}_3\text{N}_4/\text{Si}_3\text{N}_4$	
PyC content (vol.%)	Open porosity (%)	PyC content (vol.%)	Open porosity (%)
0	46	0	0
1.1	45	1.0	0
2.0	44	1.9	0
3.2	42	3.1	0
5.6	40	5.4	0
7.7	38	7.5	0

3. Results and discussion

3.1. Microstructure and porosity

Fig. 1 shows the micrographs of $\text{Si}_3\text{N}_4/\text{Si}_3\text{N}_4$ and $\text{PyC-Si}_3\text{N}_4/\text{Si}_3\text{N}_4$. As can be seen, the PyC is uniformly distributed in porous Si_3N_4 . The dense Si_3N_4 coating is about 30 μm thick and crack free. Table 1 lists the open porosities of $\text{PyC-Si}_3\text{N}_4$ and $\text{PyC-Si}_3\text{N}_4/\text{Si}_3\text{N}_4$ with different PyC content. By increasing CVI time, the $\text{PyC-Si}_3\text{N}_4$ with PyC content of 1.1, 2.0, 3.2, 5.6 and 7.7 vol.% are fabricated, respectively. Actually, the total amount of PyC in $\text{PyC-Si}_3\text{N}_4$ remains unchanged after CVD of Si_3N_4 , but the content of PyC in $\text{PyC-Si}_3\text{N}_4/\text{Si}_3\text{N}_4$ decreases slightly because of the increase of sample bulk. Here, the content of PyC in $\text{PyC-Si}_3\text{N}_4/\text{Si}_3\text{N}_4$ is 1.0, 1.9, 3.1, 5.4 and 7.5 vol.%, respectively. Amazingly, no matter what content of PyC in $\text{PyC-Si}_3\text{N}_4/\text{Si}_3\text{N}_4$ is, the open porosity of $\text{PyC-Si}_3\text{N}_4/\text{Si}_3\text{N}_4$ is 0% due to the excellent sealing effect of dense Si_3N_4 coating.

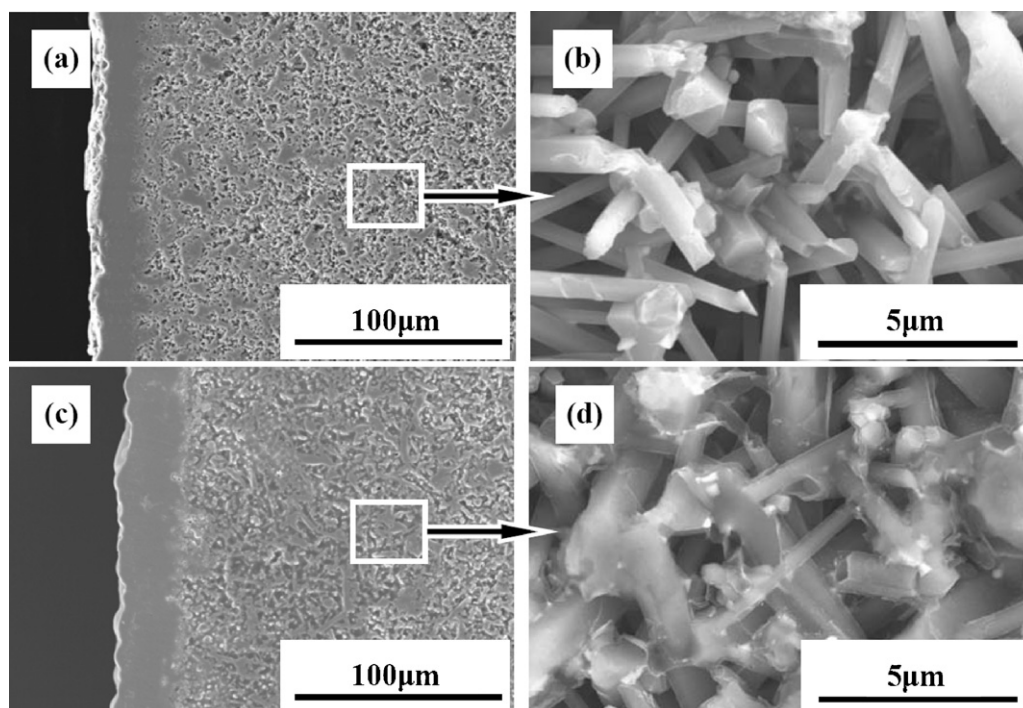


Fig. 1. Micrographs of (a, b) $\text{Si}_3\text{N}_4/\text{Si}_3\text{N}_4$ and (c, d) $\text{PyC-Si}_3\text{N}_4/\text{Si}_3\text{N}_4$.

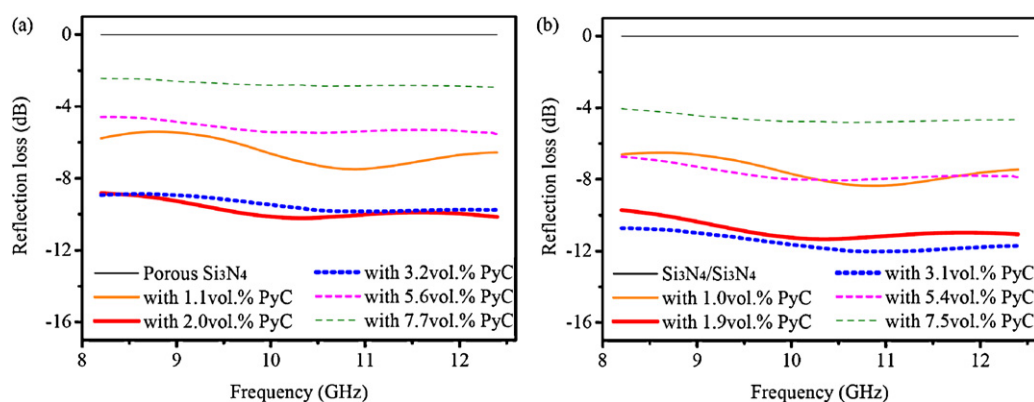


Fig. 2. Reflection losses of (a) PyC-Si₃N₄ and (b) PyC-Si₃N₄/Si₃N₄ with different PyC content.

3.2. Reflection loss of PyC-Si₃N₄ and PyC-Si₃N₄/Si₃N₄

The electromagnetic reflection loss of a material is codetermined by the reflection of electromagnetic wave occurring on the surface of the material and by the absorption of electromagnetic wave in the material. As shown in Fig. 2(a), due to the improvement of electromagnetic wave absorption ability, the mean reflection loss of PyC-Si₃N₄ decreases from −6.5 to −9.8 dB with the increase of PyC content from 1.1 to 2.0 vol.%. The electromagnetic wave absorption ability of PyC-Si₃N₄ is further improved with the increase of PyC content from 2.0 to 7.7 vol.%, but the electromagnetic wave is reflected more on the surface of PyC-Si₃N₄ because of the aggravation of impedance break between air and PyC-Si₃N₄. When the electromagnetic wave enters PyC-Si₃N₄, the absorption of electromagnetic wave can occur, so the mean reflection loss of PyC-Si₃N₄ increases from −9.8 to −2.7 dB with the increase of PyC content from 2.0 to 7.7 vol.%.

After CVD of Si₃N₄, the amount of electromagnetic wave reflected on the surface of PyC-Si₃N₄/Si₃N₄ decreases obviously because the impedance break between air and PyC-Si₃N₄ is weakened by Si₃N₄ coating. The dense Si₃N₄ coating improves the entry of electromagnetic waves into PyC-Si₃N₄/Si₃N₄, where they can be absorbed. The comparison of reflection losses of the samples with the same PyC content, but without or with CVD Si₃N₄ coating shows [Fig. 2(a) and (b)] that PyC-Si₃N₄/Si₃N₄ possesses lower reflection loss than PyC-Si₃N₄. The mean reflection loss of PyC-Si₃N₄/Si₃N₄ with 3.1 vol.% PyC content reaches −11.5 dB [Fig. 2(b)], while it is −9.5 dB for PyC-Si₃N₄ with 3.2 vol.% PyC content [Fig. 2(a)].

3.3. Oxidation resistance of PyC-Si₃N₄ and PyC-Si₃N₄/Si₃N₄

The majority of carbon-based materials, including PyC-Si₃N₄ possess bad oxidation resistance. Fig. 3(a) shows the weight change of PyC-Si₃N₄ sample with 2.0 vol.% PyC content after oxidation at 700 °C. The weight of PyC-Si₃N₄ sample decreases gradually as the oxidation time increases from 1 to 5 h due to the oxidation of PyC in PyC-Si₃N₄. As the oxidation time increases to more than 5 h the PyC is completely burned

out in PyC-Si₃N₄ sample, so the weight of PyC-Si₃N₄ sample remains unchanged with the time of oxidation.

Fig. 3(b) shows the weight change of PyC-Si₃N₄/Si₃N₄ samples with PyC content of 1.0, 3.1 and 7.5 vol.% respectively after oxidation at 700–1300 °C for 10 h. As can be seen, the weight of PyC-Si₃N₄/Si₃N₄ samples increases slightly with the increase of oxidation temperature from 700 to 1100 °C, and then decreases rapidly when the oxidation temperature reaches 1300 °C. The oxidation product of Si₃N₄ is amorphous silica when Si₃N₄ is oxidized at temperatures below 1100 °C.¹⁴ The little increase of PyC-Si₃N₄/Si₃N₄ samples in weight after oxidation at 900 °C and 1100 °C is due to the oxidation of Si₃N₄ coating. When the oxidation temperature reaches 1300 °C, the oxidation rate of Si₃N₄ coating increases and the oxidation-derived silica transforms into cristobalite quickly.¹⁵ Because there is a significant difference in the coefficient of thermal expansion (CTE) between silica and cristobalite, the transformation from silica to cristobalite initiates crack formation in the dense Si₃N₄ coating. Afterwards oxygen can penetrate through the cracked Si₃N₄ coating and react with PyC in the porous PyC-Si₃N₄ body. Therefore, the rapid weight decrease of the PyC-Si₃N₄/Si₃N₄ samples after oxidation at 1300 °C for 10 h is due to the oxidation of PyC.

The oxidation test of PyC-Si₃N₄/Si₃N₄ sample with 3.1 vol.% PyC at 1300 °C shows a small weight change up to 4 h [Fig. 3(c)]. During the oxidation process PyC and Si₃N₄ are oxidized at the same time. The oxidation of PyC decreases the weight of sample due to the formation of CO and CO₂ gases, while the oxidation of Si₃N₄ is connected by weight gain. At the beginning of oxidation process, oxygen can hardly enter the Si₃N₄-coated PyC-Si₃N₄/Si₃N₄ sample because there are only few small cracks in Si₃N₄ coating, so the amount of PyC in PyC-Si₃N₄/Si₃N₄ remains almost unchanged. The weight of PyC-Si₃N₄/Si₃N₄ sample increases at the beginning of oxidation process, because the oxidation rate of Si₃N₄ coating is faster than that of PyC under this protecting layer. As the oxidation time increases from 2 to 10 h, the number and size of cracks in Si₃N₄ coating increases, it is easier for oxygen to enter the porous PyC-Si₃N₄ body and react with PyC. The weight of PyC-Si₃N₄/Si₃N₄ sample decreases rapidly because the oxidation rate of PyC is faster than that of Si₃N₄. As the oxidation time increases to more than 10 h, the PyC is completely burned out in PyC-Si₃N₄/Si₃N₄

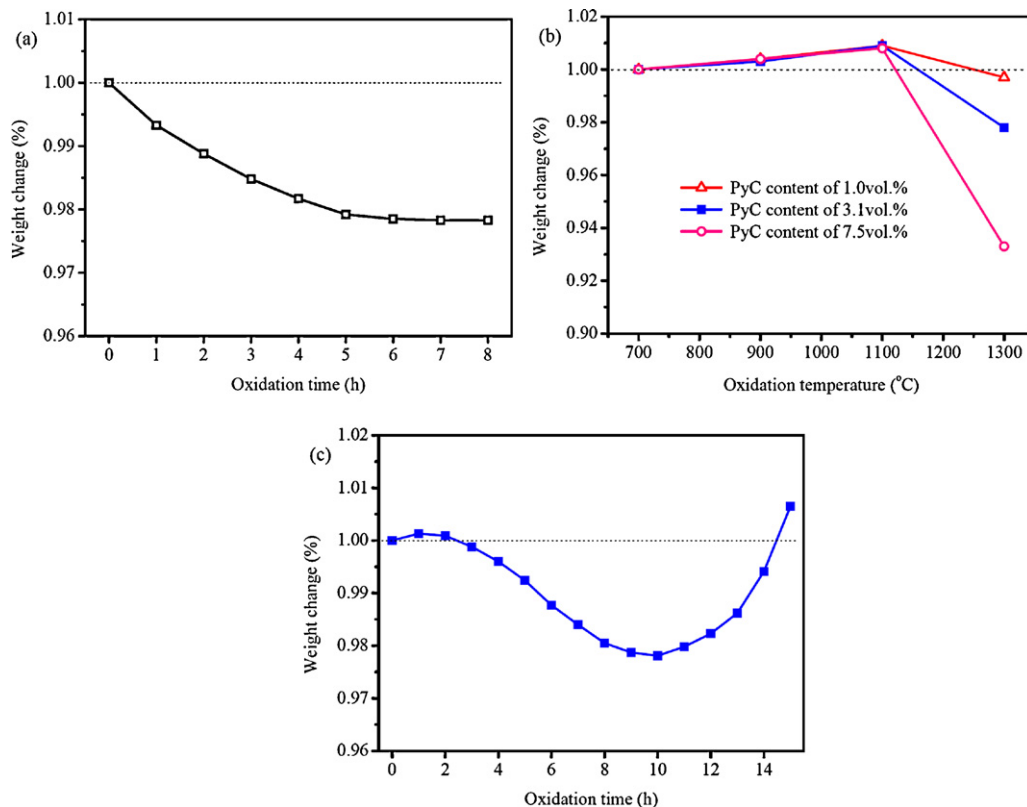


Fig. 3. Weight changes of (a) PyC-Si₃N₄ sample with 2.0 vol.% PyC content after oxidation at 700 °C, (b) PyC-Si₃N₄/Si₃N₄ samples with PyC content of 1.0, 3.1 and 7.5 vol.% respectively after oxidation at 700–1300 °C for 10 h, and (c) PyC-Si₃N₄/Si₃N₄ sample with 3.1 vol.% PyC content after oxidation at 1300 °C.

sample. However, the oxidation of Si₃N₄ further proceeds, so the weight of PyC-Si₃N₄/Si₃N₄ sample again increases with the time of oxidation.

3.4. Reflection loss of PyC-Si₃N₄ and PyC-Si₃N₄/Si₃N₄ after oxidation

Fig. 4 shows the reflection losses of PyC-Si₃N₄ with 2.0 vol.% PyC content after oxidation at 700 °C, and that of PyC-Si₃N₄/Si₃N₄ with 3.1 vol.% PyC content after oxidation at 1100 °C. The mean reflection loss of PyC-Si₃N₄ increases obviously from −7.0 to −0.3 dB with the increase of oxidation time from 1 to 5 h at 700 °C [Fig. 4(a)], because the content of PyC

in PyC-Si₃N₄ decreases. Contrary, in PyC-Si₃N₄/Si₃N₄ sample the PyC is not oxidized at 1100 °C due to the protection of Si₃N₄ coating, but there is a thin SiO₂ layer formed at the surface of Si₃N₄ coating. Theoretically, SiO₂ layer has little effect on the reflection loss of PyC-Si₃N₄/Si₃N₄ because SiO₂ is a good wave-transparent material. However, SiO₂ layer can weaken the impedance break between air and Si₃N₄ coating, which makes easier the entry of electromagnetic waves into PyC-Si₃N₄/Si₃N₄ sample. Therefore, the mean reflection loss of PyC-Si₃N₄/Si₃N₄ after 2 h oxidation is −11.8 dB, which is only a little lower than that for as-obtained PyC-Si₃N₄/Si₃N₄ [Fig. 4(b)]. Once SiO₂ layer forms, the little increase of the thickness of SiO₂ layer has no effect on the impedance break between air and Si₃N₄ coating,

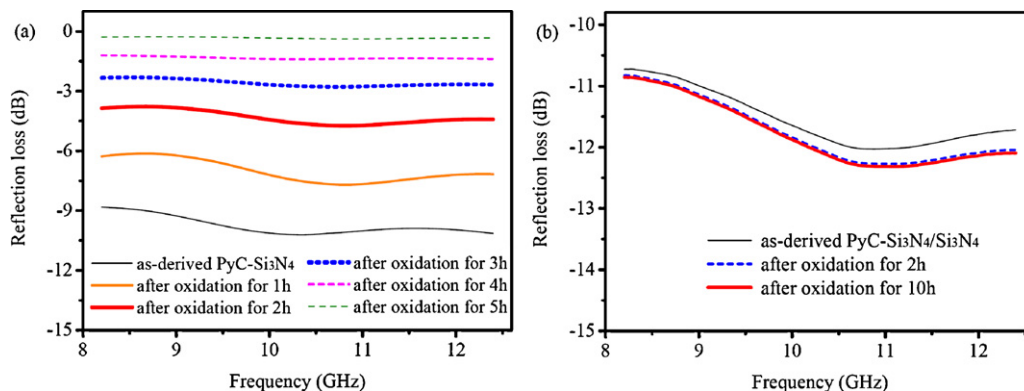


Fig. 4. Reflection losses of (a) PyC-Si₃N₄ with 2.0 vol.% PyC content after oxidation at 700 °C, and (b) PyC-Si₃N₄/Si₃N₄ with 3.1 vol.% PyC content after oxidation at 1100 °C.

so the reflection loss of PyC-Si₃N₄/Si₃N₄ remains unchanged as the oxidation time increases from 2 to 10 h.

4. Conclusions

In this study the fabrication of Si₃N₄-coated porous PyC-Si₃N₄/Si₃N₄ ceramic was done by CVD of PyC into porous Si₃N₄ ceramic and by subsequent CVD of Si₃N₄ coating on its surface. The electromagnetic reflection loss of PyC-Si₃N₄/Si₃N₄ with 3.1 vol.% PyC content reaches −11.5 dB. Because of the excellent sealing effect of dense Si₃N₄ coating, the PyC-Si₃N₄/Si₃N₄ possesses remarkable oxidation resistance. The PyC-Si₃N₄/Si₃N₄ is a good electromagnetic absorbing material not only at room temperature but also at temperatures as high as 1100 °C.

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